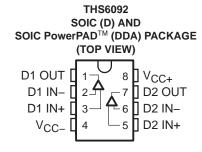
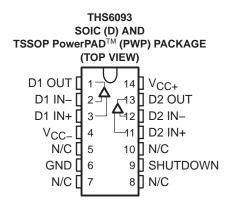
SLOS345C - JANUARY 2001 - REVISED OCTOBER 2002

- Remote Terminal ADSL Line Driver
 - Ideal for Both Full Rate ADSL and G.Lite
 - Compatible With 1:2 Transformer Ratio
- Wide Supply Voltage Range +5 V to +14 V
 - Ideal for Single Supply +12-V Operation
- Low 2.1 pA/√Hz Noninverting Current Noise
 - Reduces Noise Feedback Through Hybrid Into Downstream Channel
- Wide Output Swing
 - 18.4 Vpp Differential Output Voltage, R_I = 50 Ω , 12-V Single Supply
- High Output Current
 - 275 mA (typ)



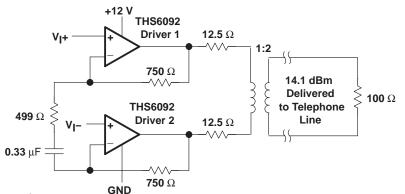
High Speed

- 100 MHz (-3 dB, G=1, 12-V Single Supply)
- 600 V/μs Slew Rate (G = 4, 12-V Single Supply)
- Low Distortion, Single-Ended, G = 4
 - 72 dBc (250 kHz, 2 Vpp, 25 Ω load)
 - 78 dBc (250 kHz, 2 Vpp, 100 Ω load)
- Low Power Shutdown (THS6093)
 - 300 μA Total Standby Current
- Thermal Shutdown and Short Circuit Protection
- Standard SOIC, SOIC PowerPAD™, and TSSOP PowerPAD™ Package
- Evaluation Module Available



description

The THS6092/3 is a high-speed line driver ideal for driving signals from the remote terminal to the central office in asymmetrical digital subscriber line (ADSL) applications. It can operate from a single +12-V supply voltage while drawing only 7.3 mA of supply current per channel. It offers low –72 dBc total harmonic distortion driving a 25- Ω load (2 Vpp). The THS6092/3 offers a high 18.4-Vpp differential output swing across a 50- Ω load from a single +12-V supply. The THS6093 features a low-power shutdown mode, consuming only 300 μ A quiescent current per channel. The THS6092/3 is packaged in a standard SOIC, SOIC PowerPADTM, and TSSOP PowerPADTM package.



RELATED PRODUCTS

| DEVICE | DESCRIPTION |
|-----------|---|
| THS6042/3 | 350-mA, ±12 ADSL CPE line driver |
| THS6052/3 | 175-mA, \pm 12 V ADSL CPE line driver |
| OPA2677 | 380-mA, +12 V ADSL CPE line driver |
| THS6062 | Low noise ADSL receiver |



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerPAD is a trademark of Texas Instruments.

TEXAS INSTRUMENTS

AVAILABLE OPTIONS

| | | PACKAGED DEVICE | | | | | |
|---------------|----------------|------------------------------|--------------------------|-------------|--------------------------|--|--|
| TA | SOIC-8† (D) | SOIC-8† PowerPAD (DDA) | werPAD SOIC-14T PowerPAD | | EVALUATION MODULES | | |
| 0°C to 70°C | THS6092CD | THS6092CDDA | THS6093CD | THS6093CPWP | THS6092EVM THS6093EVM | | |
| -40°C to 85°C | THS6092ID | THS6092IDDA | THS6093ID | THS6093IPWP | _ | | |

[†] All packages are available taped and reeled. Add an R-suffix to the device type (i.e., THS6092IDR).

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

| Supply voltage, V _{CC+} to V _{CC-} | 14.7 V |
|---|-------------------------------|
| Input voltage | |
| Output current (see Note 1) | 350 mA |
| Differential input voltage | ± 3 V |
| Maximum junction temperature | 150°C |
| Total power dissipation at (or below) 25°C free-air temperature | See Dissipation Ratings Table |
| Operating free-air temperature, T _A : Commercial | |
| Industrial | –40°C to 85°C |
| Storage temperature, T _{stq} : Commercial | –65°C to 125°C |
| Industrial | |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 300°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The THS6092 and THS6093 may incorporate a PowerPAD™ on the underside of the chip. This acts as a heatsink and must be connected to a thermally dissipating plane for proper power dissipation. Failure to do so may result in exceeding the maximum junction temperature which could permanently damage the device. See TI Technical Brief SLMA002 for more information about utilizing the PowerPAD™ thermally enhanced package.

DISSIPATION RATING TABLE

| PACKAGE | θЈА | θЈС | T _A = 25°C§ POWER RATING | T _A = 70°C§ POWER RATING | T _A = 85°C§ POWER RATING |
|---------|---------------------|-----------------------|--|--|--|
| D-8 | 95°C/W [‡] | 38.3°C/W [‡] | 1.1 W | 0.63 W | 0.47 W |
| DDA | 45.8°C/W | 9.2°C/W | 2.3 W | 1.31 W | 0.98 W |
| D-14 | 66.6°C/W‡ | 26.9°C/W‡ | 1.6 W | 0.90 W | 0.68 W |
| PWP | 37.5°C/W | 1.4°C/W | 2.8 W | 1.60 W | 1.20 W |

[‡] This data was taken using the JEDEC proposed high-K test PCB. For the JEDEC low-K test PCB, the Θ_{JA} is168°C/W for the D–8 package and 122.3°C/W for the D–14 package.

recommended operating conditions

| | | MIN | NOM MAX | UNIT |
|--|---------------|------|---------|------|
| Supply voltage Vee, to Vee | Dual supply | ±2.5 | ±7 | ., |
| Supply voltage, V _{CC+} to V _{CC-} | Single supply | +5 | +14 | V |
| On and the office of the control of T | C-suffix | 0 | 70 | |
| Operating free-air temperature, T _A | I-suffix | -40 | 85 | °C |



[§] Power rating is determined with a junction temperature of 130°C. This is the point where distortion starts to substantially increase. Thermal management of the final PCB should strive to keep the junction temperature at or below 125°C for best performance.

electrical characteristics over recommended operating free-air temperature range, T_A = 25°C, V_{CC+} = 12 V, V_{CC-} = GND, R_{FEEDBACK} = 750 Ω , R_L = 25 Ω (unless otherwise noted)

dynamic performance

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
|---------------------------------------|------------------------------------|------------------------|-----|-----|-----|------|--|
| BW Small-signal bandwidth (-3 dB) G=1 | V _{CC} = 12 V | | 100 | | | | |
| BVV | Small-signal bandwidth (-3 dB) G=1 | V _{CC} = 5 V | | 90 | | MHz | |
| CD | SR Slew rate (see Note 2) | V _{CC} = 12 V | | 600 | | Miss | |
| SK | | V _{CC} = 5 V | | 400 | | V/μs | |

NOTE 2: Slew rate is defined from the 25% to the 75% output levels.

noise/distortion performance

| | PARAMETER | | TEST CON | DITIONS | MIN | TYP | MAX | UNIT |
|------------|-------------------------------|--|--|--------------------------|-----|------|-----|--------|
| | TUD Total harmonic distortion | Gain = 4, $R_L = 25 \Omega$, $V_{CC} = 5 V$, $f = 250 \text{ kHz}$ | V _{O(pp)} = 2 V | | -70 | | | |
| THD | (single-ended config | (single-ended configuration) | Gain = 4, $R_L = 25 \Omega$, | V _{O(pp)} = 2 V | | -72 | | dBc |
| | | | $V_{CC} = 12 \text{ V}, f = 250 \text{ kHz}$ | V _{O(pp)} = 7 V | -68 | | | |
| ٧n | Input voltage noise | | V _{CC} = 12 V, 5 V, f = 10 kHz | | | 2.1 | | nV/√Hz |
| | Innut ourrent noise | +Input | V 42.V.E.V. f. 40.H.I= | V 40 V 5 V 5 40 H I- | | 2.1 | | pA/√Hz |
| I n | Input current noise | -Input | V _{CC} = 12 V, 5 V, f = 10 kHz | | | 10.9 | | pA/√HZ |
| XT | Crosstalk | | $ \begin{array}{ll} f = 250 \text{ kHz} \; , & \text{V}_{\mbox{O}} = 2 \; \mbox{Vpp} \\ \mbox{G} = 4, & \text{R}_{\mbox{L}} = 25 \; \Omega \end{array} $ | V _{CC} = 5 V | | -65 | | dBc |
| - I | | | | V _{CC} = 12 V | | -63 | | |

dc performance

| | PARAMETER | TEST C | ONDITIONS | MIN | TYP | MAX | UNIT |
|------|---------------------------------|-----------------------------|-----------------------------|-----|-----|-----|-----------|
| | long to effect yeltogo | | T _A = 25°C | | 6 | 16 | |
| | Input offset voltage | | T _A = full range | | | 21 | \/ |
| Vos | Differential effect voltage | V _{CC} = 12 V, 5 V | T _A = 25°C | | 1 | 6 | mV |
| | Differential offset voltage | | T _A = full range | | | 8 | |
| | Offset drift | | T _A = full range | | 20 | | μV/°C |
| | - Input bias current | | T _A = 25°C | | 3 | 10 | |
| | - Input bias current | | T _A = full range | | | 12 | |
| lun. | I loout bigg gurrant | Voc - 12 V 5 V | T _A = 25°C | | 1 | 6 | ^ |
| ΙΒ | + Input bias current | V _{CC} = 12 V, 5 V | T _A = full range | | | 7 | μΑ |
| | Differential input bias current | | T _A = 25°C | | 3 | 10 | |
| | Differential input bias current | | T _A = full range | | | 12 | |
| ZOL | Open loop transimpedance | $R_L = 1 k\Omega$ | V _{CC} = 12 V, 5 V | | 0.9 | | $M\Omega$ |

SLOS345C - JANUARY 2001 - REVISED OCTOBER 2002

electrical characteristics over recommended operating free-air temperature range, T_A = 25°C, V_{CC+} = 12 V, V_{CC-} = GND, R_{FEEDBACK} = 750 Ω , R_L = 25 Ω (unless otherwise noted) (continued)

input characteristics

| | PARAMETER | TEST COND | ITIONS | MIN | TYP | MAX | UNIT |
|--------------------|------------------------------------|------------------------|-----------------------------|------------|-------------|-----|------|
| | | V _{CC} = 5 V | T _A = 25°C | 1.5 to 3.5 | 1.1 to 3.9 | | |
| \/ | Input common-mode voltage range | vCC = 2 v | T _A = full range | 1.6 to 3.4 | | | V |
| V _{ICR} I | | Va = 42 V | T _A = 25°C | 2.3 to 9.7 | 1.8 to 10.2 | | V |
| | | V _{CC} = 12 V | T _A = full range | 2.4 to 9.6 | | | |
| | | V _{CC} = 5 V | T _A = 25°C | 56 | 63 | | |
| CMRR | Occurred and the materials and the | | T _A = full range | 54 | | | dB |
| CIVIKK | Common-mode rejection ratio | Va = 42 V | T _A = 25°C | 50 | 56 | | uБ |
| | | V _{CC} = 12 V | T _A = full range | 48 | | | |
| р. | Input registance | + Input | | | 1 | | MΩ |
| R _l | Input resistance | -Input | · | | 15 | | Ω |
| CI | Input capacitance | | | | 2 | | pF |

output characteristics

| | PARAMETER | | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|-----|---|------------------|--------------------------|------------------------|-------------|--------------|-----|------|
| | | | D 05.0 | V _{CC} = 5 V | 1.4 to 3.6 | 1.1 to 3.9 | | |
| ., | Vo Output voltage swing Single ended 100 mV overdrive | Single ended | $R_L = 25 \Omega$ | V _{CC} = 12 V | 1.9 to 10.1 | 1.4 to 10.6 | | ., |
| ۷O | | 100 mV overdrive | drive $R_L = 100 \Omega$ | V _{CC} = 5 V | 1.3 to 3.7 | 1.05 to 3.95 | | V |
| | | | | V _{CC} = 12 V | 1.5 to 10.5 | 1.1 to 10.9 | | |
| | Output summer! | | $R_L = 3.6 \Omega$, | V _{CC} = 5 V | | 240 | | A |
| IO | Output current | | $R_L = 10 \Omega$, | V _{CC} = 12 V | 240 | 275 | | mA |
| Isc | Short-circuit current | | $R_L = 0 \Omega$, | V _{CC} = 12 V | | 325 | | mA |
| | Output resistance | | Open loop | | | 15 | | Ω |

power supply

| | PARAMETER | | | TEST CONDITIONS | | TYP | MAX | UNIT |
|---------------------------------|---------------------------------|----------------------------------|------------------------|-----------------------------|-----|-----|------|------|
| ., | On and the second | Dual supply | | | | | ±7 | ., |
| V _{CC} Operating range | | Single supply | | | 4.5 | | 14 | V |
| | | | V _{CC} = 5 V | T _A = 25°C | | 6.7 | 8.8 | A |
| loo | Outroport compat (analy driver) | Outros and suggest (analysis and | | T _A = full range | | | 10 | mA |
| Icc | Quiescent current (each driver) | | V 40 V | $T_A = 25^{\circ}C$ | | 7.3 | 9.5 | 4 |
| | | | V _{CC} = 12 V | T _A = full range | | | 10.5 | mA |
| | | | ., | T _A = 25°C | -54 | -58 | | |
| DODD | Barrer are to refer the rest. | | $V_{CC} = 5 V$ | T _A = full range | -46 | - | | .10 |
| PSRR | Power supply rejection ratio | | V 40 V | T _A = 25°C | -58 | -70 | | dB |
| | | | V _{CC} = 12 V | T _A = full range | -50 | | | |



SLOS345C - JANUARY 2001 - REVISED OCTOBER 2002

electrical characteristics over recommended operating free-air temperature range, T_A = 25°C, V_{CC+} = 12 V, V_{CC-} = GND, $R_{FEEDBACK}$ = 750 Ω , R_L = 25 Ω (unless otherwise noted) (continued)

shutdown characteristics (THS6093 only)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------|--|---|-----|-----|-----|------|
| VIL(SHDN) | Shutdown pin voltage for power up | V _{CC} = 12 V, GND = 6 V (GND Pin as Reference) | | | 0.8 | V |
| VIH(SHDN) | Shutdown pin voltage for power down | V _{CC} = 12 V, GND = 6 V (GND Pin as Reference) | 2 | | | V |
| ICC(SHDN) | Total quiescent current when in shutdown state | V _{SHDN} = 8 V, V _{GND} = 6 V, V _{CC} = 12 V | | 0.3 | 0.7 | mA |
| tDIS | Disable time (see Note 3) | V _{CC} = 12 V | | 0.2 | | μs |
| tEN | Enable time (see Note 3) | V _{CC} = 12 V | | 0.5 | | μs |
| IL(SHDN) | Shutdown pin input bias current for power up | V _{SHDN} = 6 V, V _{GND} = 6 V, V _{CC} = 12 V | | 40 | 100 | μА |
| lih(SHDN) | Shutdown pin input bias current for power down | V _{SHDN} = 9.3 V, V _{GND} = 6 V, V _{CC} = 12 V | | 50 | 100 | μΑ |

NOTE 3: Disable/enable time is defined as the time from when the shutdown signal is applied to the SHDN pin to when the supply current has reached half of its final value.

APPLICATION INFORMATION

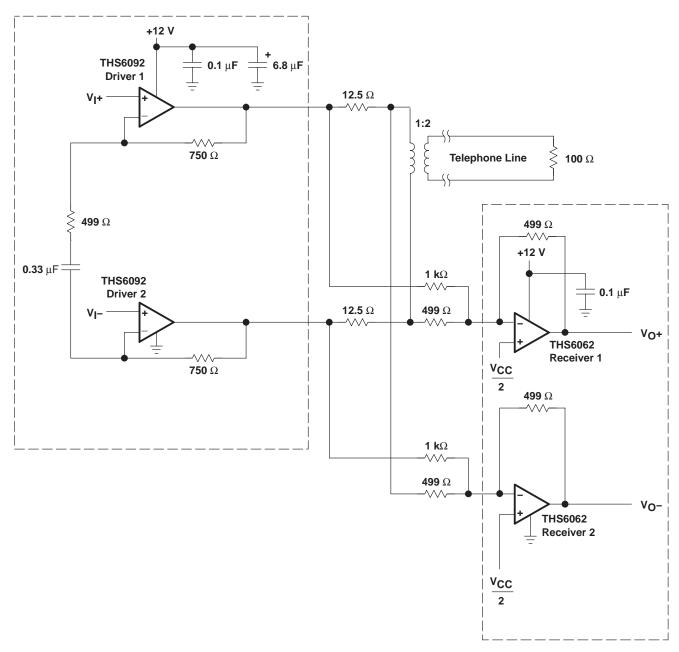


Figure 1. THS6092 ADSL Application With 1:2 Transformer Ratio



www.ti.com 6-Apr-2024

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|---------------------|--------------|-------------------------|---------|
| THS6092ID | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 60921 | Samples |
| THS6093CPWPR | ACTIVE | HTSSOP | PWP | 14 | 2000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | 0 to 70 | HS6093C | Samples |
| THS6093IPWP | ACTIVE | HTSSOP | PWP | 14 | 90 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | HS6093I | Samples |
| THS6093IPWPR | ACTIVE | HTSSOP | PWP | 14 | 2000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | HS6093I | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

www.ti.com 6-Apr-2024

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PACKAGE MATERIALS INFORMATION

www.ti.com 5-Dec-2023

TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| THS6093CPWPR | HTSSOP | PWP | 14 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |
| THS6093IPWPR | HTSSOP | PWP | 14 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |

www.ti.com 5-Dec-2023



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) | |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|--|
| THS6093CPWPR | HTSSOP | PWP | 14 | 2000 | 350.0 | 350.0 | 43.0 | |
| THS6093IPWPR | HTSSOP | PWP | 14 | 2000 | 350.0 | 350.0 | 43.0 | |

PACKAGE MATERIALS INFORMATION

www.ti.com 5-Dec-2023

TUBE



*All dimensions are nominal

| | Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) | |
|---|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|--|
| | THS6092ID | D | SOIC | 8 | 75 | 505.46 | 6.76 | 3810 | 4 | |
| ĺ | THS6093IPWP | PWP | HTSSOP | 14 | 90 | 530 | 10.2 | 3600 | 3.5 | |

4.4 x 5.0, 0.65 mm pitch

PLASTIC SMALL OUTLINE

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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